FIBER OPTIC RECEIVING MODULE

■ FEATURES

1) Conform to EIAJ standard CP-1201 (For Digital audio interfaces including fiber optic inter-connections). GOODTAKE

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- 2) A self-tapping hole for easy attachment to audio equipments panels.
- 3) +5V single power supply.
- 4) High-speed signal receiving (13.2M NRZ signal).
- 5) ESD tolerance IC>8kV.
- 6) Standard package (panel mount type).

APPLICATIONS

- 1) Digital audio equipment
- 2) Navigation system.

GOODTAKE ■ MAXIMUM RATINGS (Ta=25 °C)

Characteristic	Symbol	Rating	Units	
Supply Voltage	Vcc	-0.5 to 5.5	V	
High Level Output Current	Іон	20	μΑ	
Low Level Output Current	lol	-2	mA	
Operating Temperature	Topr	-20 to 70	°C	
Storage Temperature	Tstg	-40 to 70	°C	
Soldering Temperature	TsoL	260*1	သိ	

^{*1:} Soldering time≤10 seconds.

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GOODTAKE RECOMMENDED OPERATING CONDITIONS AND ELECTRICAL CHARACTERISTICS (Ta=25 °C, Vcc=5V)

Characteristic	Symbol	Condition	Min	Тур	Max	Units
Operating Voltage	Vcc		2.4	3.0	5.5	V
Date Rate	Т	NRZ Code *1	0.1	-	13.2	Mb/s
Peak Detective Wavelength	λр		-	660	-	nm
Transmission Distance		Using APF *2 Using HKTX179LDS	0.2	-	5	E
Pulse Width Distortion *3	∆tw	Pulse width =160ns Pulse cycle =320ns, CL=10pF Using HKTX179A	-25	- -	25	ns
Maximum Receivable Power	Рмах	6Mb/s, Using APF:*2	-11	-	-	dBm
Minimum Receivable Power	Рмім	6Mb/s, Using APF:*2	-	-	-23	dBm
Current Consumption	lcc _	Vcc=+5V	-	10	20	μΑ
High Level Output Voltage	Voн		2.1	2.5		V
Low Level Output Voltage	Vol		-	0.2	0.4	V

^{*1:} When non-modulated signal (optical all high or all low level signal) is inputted, output signal is not stable.

When modulated optical high level signal is received, output signal is high.

When modulated optical low level signal is received, output signal is low.

The duty factor must be maintained between 25 to 75%.

■ MECHANICAL CHARACTERISTICS (Ta=25°C)

Characteristic	Symbol	Condition	Min	Тур	Max	Units
Insertion Force		*1	-	-	40	N
Withdrawal Force		*1	6	-	40	N
Torque for Self-Tap		Using self-tapping screw (M3*8)	60	-	100	N-cm

^{*1:} Using standard optical fiber cable. (970/1000 µm)

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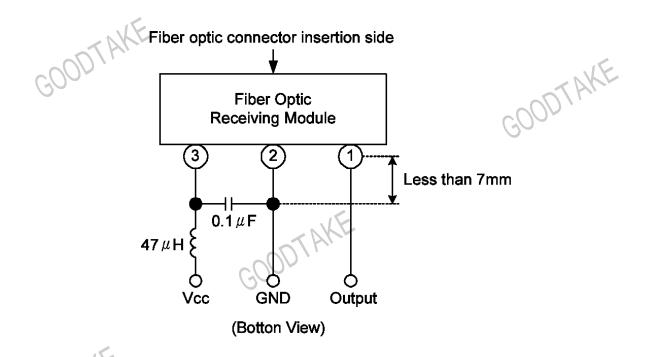
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^{*2:} APF: All Plastic Fiber (970/1000 μm).Length 1 meter.

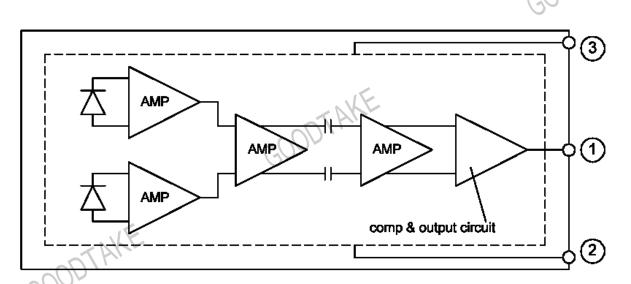
^{*3:} Between input of transmitting module and output of HKRX178LDS.

■ APPLICATION CIRCUIT



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BLOCK DIAGRAM



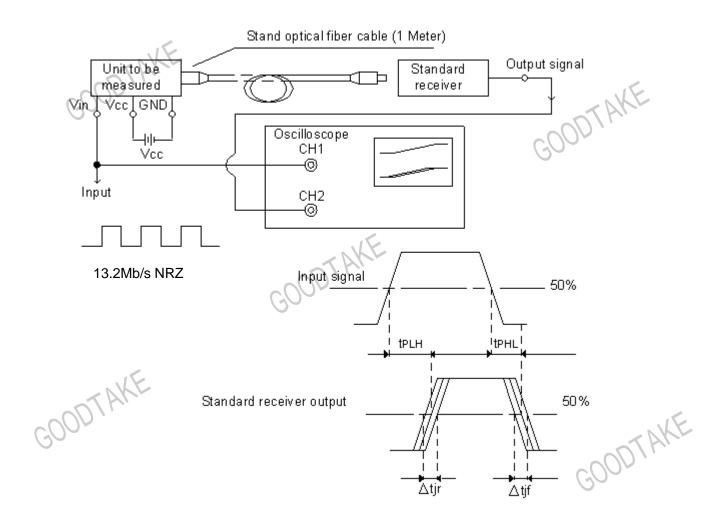
PIN CONNECTION:

① VOUT

② GND

(3) VCC

TEST CIRCUIT



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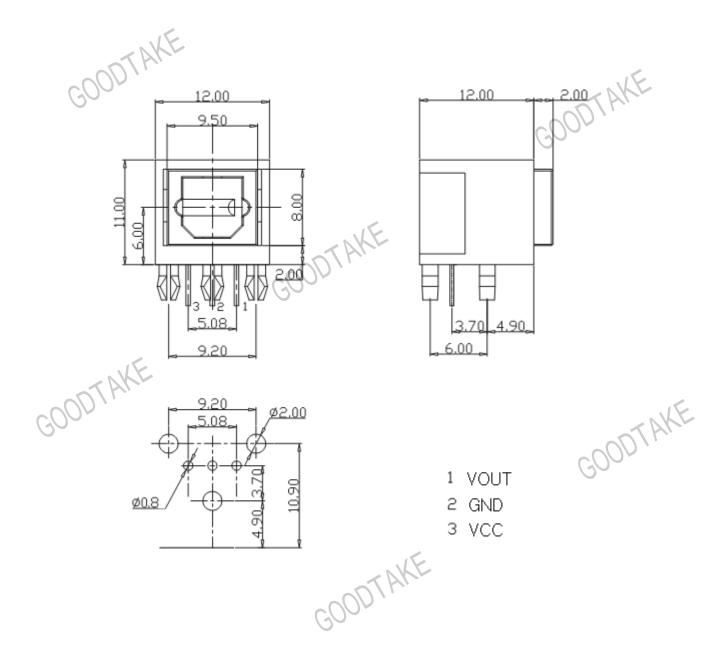
■ COMMENTS

■ COMMEN	TTS	
No.	Test Item	Symbol
1	Low to High Pulse Delay Time	t _{PLH}
2	High to Low Pulse Delay Time	t _{PHL}
3	Pulse Width Distortion	Δtw
3	$\Delta tw = t_{PHL} - t_{PLH}$	Δtw
4	High Level Output Voltage	V_{OH}
5	Low Level Output Voltage	V_{OL}



■ HKRX178LDS

OUTLINE DIMENSION Unit: mm



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■ PRECAUTIONS DURING USE

1) Maximum rating

The maximum ratings are the limit values which must not be exceeded during operating of device. None of these rating value must not be exceeded. If the maximum rating is exceeded, the characteristics of device may never be restored properly. In extreme cases, the device may be permanently damages.

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2) Soldering

Optical modules are comprised of internal semiconductor devices. However, in principle, optical modules are optical components. During soldering, ensure that flux dose not contact the emitting surface or detecting surface. Also ensure that proper flux removal is conducted after soldering. Some optical modules come with protective cap. The protective cap is used to avoid malfunction when the optical module is not in use. Note that it is not dust or waterproof.

As mentioned before, optical modules are optical component. Thus, in principle, soldering where there may be flux residue or flux removal after soldering is not recommended. GOOD TAKE recommends that soldering be performed without the optical module mounted on the board. Then, after the board has been cleaned, the optical module should be soldered manually. Do not perform any further cleaning. If the optical module cannot be soldered manually, use non-halogen (chlorine-free) flux and make sure, without cleaning, there is no residue such as chlorine. This is one of the ways to eliminate the effects of flux. In such a case, be sure to check the devices' reliability.

3) Noise resistance

It is believed that the use of optical transfer devices improve noise resistance. In theory, optical fiber is not ODTAKE affected by noise at all. However, receiving modules which handle signals whose level is extremely small, are susceptible to noise.

4) Vibration and shock

This module is plastic sealed and has its wire by resin. This structure is relatively resistant to vibration or shock. In actual equipment, there are some cases in which vibration, shock, and stress is applied to soldered parts or connected parts, resulting in line cut. A care must be take in the design of equipment which will be subject to high level of vibration.

5) Support pins

The HKRX178LDS has support pins in order to fix itself to the PCB temporary. Please make the hole for these pins in the PCB under the condition described in board layout hole patten.

6) Panel attachment

HKRX178LDS has hole for panel attachment. Please be sure to attach it to panel with self-tapping screw.

7) Solvent

When using solvent for flux removal, do not use a high acid or high alkali solvent. Be careful not to pour solvent in the optical connector ports. If solvent is inadvertently poured in to them, clean it off using cotton tips.

8) Supply voltage

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HKRX178LDS

Use the supply voltage within the recommended operating condition ($Vcc = 4.5 \sim 5.5V$). Make sure that supply voltage does not exceed the maximum rating value of 7V, even for an instant.

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9) Interface

The HKRX178LDS has a TTL interface. It can be interfaced with any TTL-compatible C-MOS IC.

10) Output

If the receiver output is at low and is connected to the power supply, or if the output is high and is connected to GND, the internal IC may be destroyed.

11) Soldering condition

Solder at 260 °C or less within ten seconds.

12) Precaution when disposing of devices and packing materials

When discarding devices and packing materials, follow the procedures stipulated by local regulations in order to protect the environment against contamination.

13) Precaution during use

GOOD TAKE is continually working to improve the quality and the reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing GOOD TAKE products, to observe standards of safety, and to avoid situations in which a malfunction or failure of a GOOD TAKE product could cause loss of human life, bodily injury or damage to property.







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